

Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	I _D
150V	9mΩ@10V	90A



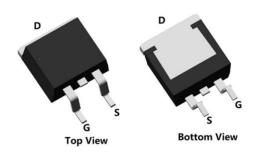
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

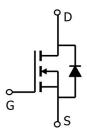
- PWM Application
- Hard switched and high frequency circuits
- Power Management

Package

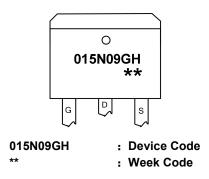


TO-263(1:G 2:D 3:S)

Circuit diagram



Marking



Order Information

Device	Package	Unit/Tape		
SP015N09GHTD	TO-263	800		



Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (Tc=25°C)	I _D	90	А
Continuous Drain Current (Tc=100°C)	I _D	60	А
Pulsed Drain Current	I _{DM}	360	А
Single Pulse Avalanche Energy ¹	Eas	462	mJ
Power Dissipation (Tc=25°ℂ)	P _D	180	W
Thermal Resistance Junction-to-Case	Rejc	0.69	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	℃
Operating Junction Temperature Range	TJ	-55 to 150	℃

Electrical characteristics (Ta=25°C, unless otherwise noted)

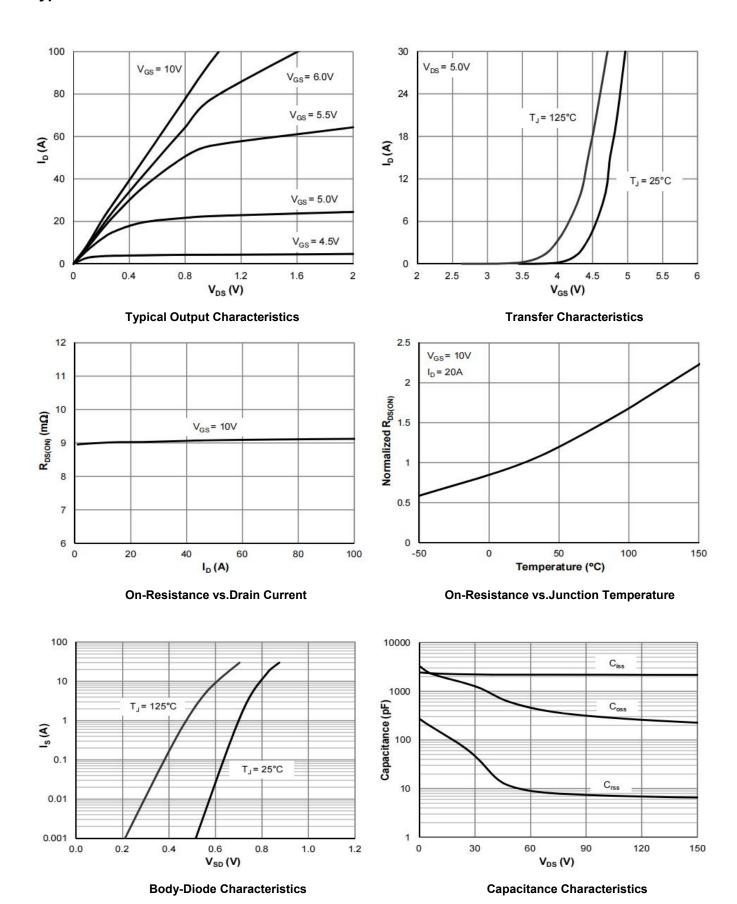
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
Drain Cut-Off Current	I _{DSS}	V _{DS} = 120V, V _{GS} = 0V	-	-	1	
Gate Leakage Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±0.1	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	2.0	3.0	4.0	V
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 20A	-	9	12	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}		_	3310	-	
Output Capacitance	Coss	VDS=75V , VGS=0V , f=1MHz	-	268	-	pF
Reverse Transfer Capacitance	C _{rss}		-	9	-	
Total Gate Charge	Qg		-	30	-	nC
Gate-Source Charge	Q _{gs}	VDS=75V , VGS=10V , ID=20A	-	17.8	-	
Gate-Drain Charge	Q_{gd}		-	7	-	
Switching Characteristics						•
Turn-On Delay Time	t _{d(on)}		-	13	-	
Rise Time	tr	VDD=75V , VGS=10V , RG=6Ω	-	25	-	
Turn-Off Delay Time	t _{d(off)}	ID=20A	-	31	-	nS
Fall Time	t _f		-	25	-	
Drain-Source Body Diode Characteri	stics					
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 1A, VGS = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	Is		-	-	90	Α
Reverse Recovery Time	Trr	IS=20A, di/dt=200A/us, TJ=25℃	-	78	-	nS
Reverse Recovery Charge	Qrr	13-20A, di/dt-200A/d5, 13-25 C	-	185	-	nC

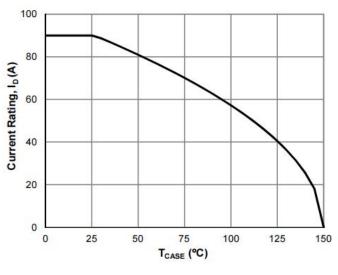
Note:

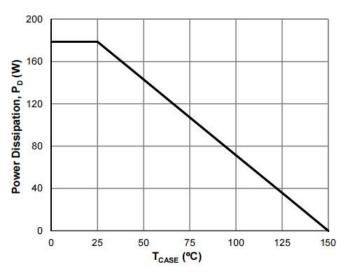
1. The test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 Ω



Typical Characteristics

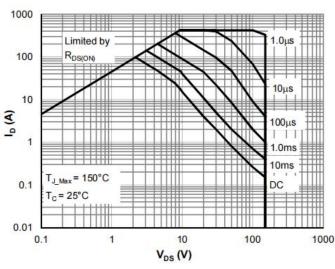


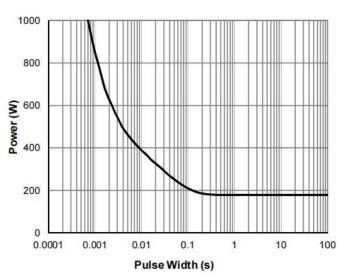




Current De-rating

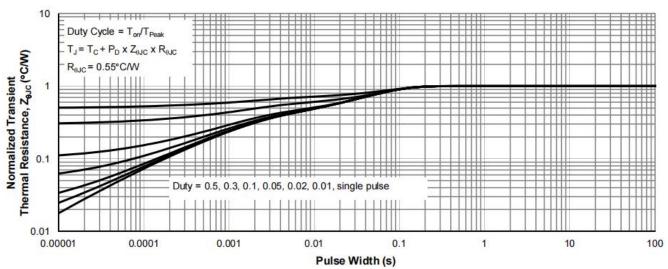
Power De-rating





Maximum Safe Operating Area

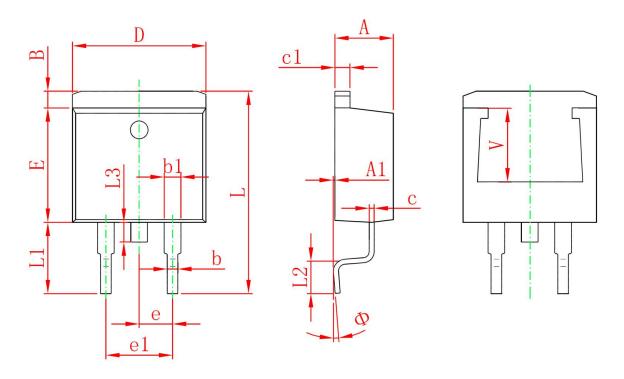
Single Pulse Power Rating, Junction-to-Case



Normalized Maximum Transient Thermal Impedance

150V N-Channel Power MOSFET

TO-263 Package Information



	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.120	1.420	0.044	0.056	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204	
L	14.940	15.500	0.588	0.610	
L1	4.950	5.450	0.195	0.215	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
Ф	0°	8°	0°	8°	
V	5.600 REF.		0.220 REF.		